

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6199003

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CAMERON MCKNIGHT-MACNEIL	06/30/2020
GREG P. KLOWAK	06/22/2020
RECEIVING PARTY DATA	
Name:	GAN SYSTEMS INC.
Street Address:	1145 INNOVATION DR.
City:	OTTAWA
State/Country:	CANADA
Postal Code:	K2K 3G8
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16928305
CORRESPONDENCE DATA	
Fax Number:	(866)397-9227
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Email:	patents@miltonsip.com
Correspondent Name:	MILTONS IP/P.I.
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Address Line 4:	OTTAWA, CANADA K2H 9G1
ATTORNEY DOCKET NUMBER:	3765-30-10
NAME OF SUBMITTER:	SHANNON PIGEON
SIGNATURE:	/Shannon Pigeon/
DATE SIGNED:	07/14/2020
Total Attachments: 8	
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WORLD INVENTION ASSIGNMENT

From: Cameron MCKNIGHT-MACNEIL
Greg P. KLOWAK,

whose full post office addresses are 4 Thatcher Street, Nepean, Ontario K2G 1S4, Canada; 51 Sherk Crescent, Ottawa, Ontario, K2K 2M6, Canada, respectively,

(the "Assignors").

To: GaN Systems Inc.,

whose full post office address is 1145 Innovation Dr., Ottawa, Ontario K2K 3G8, Canada

(the "Assignee").

The subject matter of the invention (the "Invention") is more fully described in:

United States Patent Application No. _____ entitled EMBEDDED DIE PACKAGING FOR POWER SEMICONDUCTOR DEVICES filed on _____ and in which the Inventors are named as inventors (the "Application").

In consideration of One (\$1.00) Dollar, and other good and valuable consideration duly provided by the Assignee to the Inventors, the receipt and sufficiency of which is hereby acknowledged by the Inventors:

1. The Inventors hereby irrevocably confirm the transfer and assignment, and sell, transfer and assign to the Assignee, for the Assignee's benefit and the benefit of its successors and assign, all rights, title and interest everywhere in the world, and in all countries, and regions in the world, including but not limited to Canada and the United States, in and to:
 - a. the Invention;
 - b. the right to file patent applications with respect to the Invention, all corresponding rights, title and interest in and to any priority claims;
 - c. all patent applications with respect to the Invention whether filed prior to or after the date of this assignment, including without limitation the Application and all applications under the Patent Cooperation Treaty and Paris Convention for the Invention, and any subsequent national and regional applications following thereon, and any patent applications that include additional or reduced subject matter and filed as a continuation, divisional, continuation in part, patent of addition, reissue or similar procedure; and
 - d. to receive such patents as may result from such procedures, and any patent which may issue for any aspect of the Invention.
2. The Inventors hereby further agree to communicate to the Assignee, its successors or assign any facts as may be acquired respecting the Invention and any improvements to the Invention, and without further consideration sign all lawful papers, execute all divisional, continuation, reissue and substitute

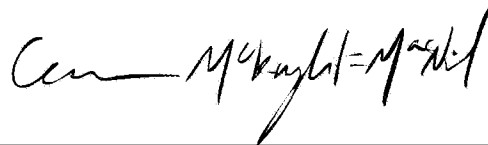
applications, make all lawful oaths, testify in any legal proceedings at the expense of the Assignee, and generally do everything reasonably possible to aid the Assignee, its successors and assigns, to obtain proper patent protection for the Invention in all countries and regions of the world.

3. This Assignment is effective the earlier of the filing date of the Application and the date it is signed by the Inventors.

Signed at 17 Fowler Street, Richmond ON, this 30th day of June, 2020_
(location)

Witness

Inventor:



Print name: _____

Print Name: Cameron MCKNIGHT-MACNEIL

Title: _____

Title: Design interpretive / R&D project lead

Location: _____

Location: _____

WITNESS'S DECLARATION

I, the undersigned Witness, do hereby [MAKE OATH][DECLARE] AND SAY that I am the witness indicated above and I did see the above referenced Inventor(s) personally sign and execute the above assignment as a fully voluntary act for the purposes set forth therein.

Sworn [Declared] before me at the City
of _____, Province/
State of _____ this
____ day of _____ 20__

A Commissioner, etc.

Witness: _____

Signed at _____, this _____ day of _____, 20__
(location)

Witness	_____	Inventor:	_____
Print name:	_____	Print Name:	Greg P. KLOWAK
Title:	_____	Title:	_____
Location	_____	Location:	_____

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Sworn [Declared] before me at the City
of _____, Province/
State of _____ this
____ day of _____ 20__

A Commissioner, etc.

Witness: _____

ACCEPTANCE

The Assignee hereby accepts the above assignment.

Witness

Assignee:

Print name:

Title:

Location

Print Name:

Title:

Location:

WORLD INVENTION ASSIGNMENT

From: Cameron MCKNIGHT-MACNEIL
Greg P. KLOWAK,

whose full post office addresses are 4 Thatcher Street, Nepean, Ontario K2G 1S4, Canada; 51 Sherk Crescent, Ottawa, Ontario, K2K 2M6, Canada, respectively,

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1. The Inventors hereby irrevocably confirm the transfer and assignment, and sell, transfer and assign to the Assignee, for the Assignee's benefit and the benefit of its successors and assign, all rights, title and interest everywhere in the world, and in all countries, and regions in the world, including but not limited to Canada and the United States, in and to:
 - a. the Invention;
 - b. the right to file patent applications with respect to the Invention, all corresponding rights, title and interest in and to any priority claims;
 - c. all patent applications with respect to the Invention whether filed prior to or after the date of this assignment, including without limitation the Application and all applications under the Patent Cooperation Treaty and Paris Convention for the Invention, and any subsequent national and regional applications following thereon, and any patent applications that include additional or reduced subject matter and filed as a continuation, divisional, continuation in part, patent of addition, reissue or similar procedure; and
 - d. to receive such patents as may result from such procedures, and any patent which may issue for any aspect of the Invention.
2. The Inventors hereby further agree to communicate to the Assignee, its successors or assign any facts as may be acquired respecting the Invention and any improvements to the Invention, and without further consideration sign all lawful papers, execute all divisional, continuation, reissue and substitute

applications, make all lawful oaths, testify in any legal proceedings at the expense of the Assignee, and generally do everything reasonably possible to aid the Assignee, its successors and assigns, to obtain proper patent protection for the invention in all countries and regions of the world.

3. This Assignment is effective the earlier of the filing date of the Application and the date it is signed by the Inventors.

Signed at _____, this _____ day of _____, 20____
(location)

Witness	_____	Inventor:	_____
Print name:	_____	Print Name:	Cameron
			MCKNIGHT-MACNEIL
Title:	_____	Title:	_____
Location	_____	Location:	_____

WITNESS'S DECLARATION

I, the undersigned Witness, do hereby [MAKE OATH][DECLARE] AND SAY that I am the witness indicated above and I did see the above referenced Inventor(s) personally sign and execute the above assignment as a fully voluntary act for the purposes set forth therein.

Sworn [Declared] before me at the City
of _____, Province/
State of _____ this
_____ day of _____ 20____

A Commissioner, etc.

Witness: _____

Signed at Ottawa Canada this 22 day of June, 2020
(location)

Witness	<u>J.A. Klowak</u>	Inventor:	<u>Greg P. Klowak</u>
Print name:	<u>Jane Ann Klowak</u>	Print Name:	<u>Greg P. KLOWAK</u>
Title:		Title:	
Location	<u>Ottawa</u>	Location:	<u>Ottawa</u>

WITNESS'S DECLARATION

I, the undersigned Witness, do hereby [MAKE OATH][DECLARE] AND SAY that I am the witness indicated above and I did see the above referenced Inventor(s) personally sign and execute the above assignment as a fully voluntary act for the purposes set forth therein.

Sworn [Declared] before me at the City
of _____ Province/
State of _____ this
____ day of _____ 20__

A Commissioner, etc.

Witness: _____

ACCEPTANCE

The Assignee hereby accepts the above assignment.

Witness

Assignee:

Print name:

Title:

Location

Print Name:

Title:

Location: